TOSHIBA Photocoupler GaAlAs IRed & Photo-Triac

TLP168J

Triac Drive

Programmable Controllers AC-Output Module

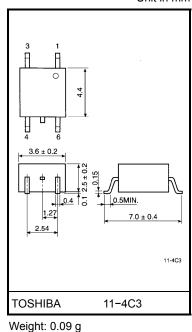
Solid State Relay

The TOSHIBA mini flat coupler TLP168J is a small outline coupler, suitable for surface mount assembly. The TLP168J consists of a photo triac, optically coupled to a GaAℓAs infrared emitting diode.

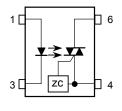
- Zero-voltage crossing turn-on
- Peak off-state voltage: 600 V (min.)
- Trigger LED current: 3 mA (max.)
- On-state current: 70 mA (max.)
- Isolation voltage: 2500 Vrms (min.)

Absolute Maximum Ratings (Ta = 25°C)

	Characteristic		Symbol	Rating	Unit
	Forward current		١ _F	20	mA
	Forward current derating (Ta ≥ 25°C)		ΔI _F / °C	-0.2	mA / °C
LED	Peak forward current (100µs pulse, 100 pps)	I _{FP}	1	A	
	Reverse voltage	V _R	5	V	
	Junction temperature	Тj	125	°C	
	Off– state output terminal voltage		V _{DRM}	600	V
	On-state RMS current	Ta=25°C		70	mA
		Ta=70°C	I _{T(RMS)}	40	mA
Detector	On–state current derating (Ta ≥ 25°C)		ΔI _T / °C	-0.67	mA / °C
De	Peak on-state current (100µs pulse, 120 pps)		I _{TP}	2	А
	Peak nonrepetitive surge current (PW=10ms, DC=10%)		I _{TSM}	1.2	А
	Junction temperature		Tj	115	°C
Stora	age temperature range		T _{stg}	-55~125	°C
Oper	ting temperature range		T _{opr}	-40~100	°C
Lead	soldering temperature (10s)		T _{sol}	260	°C
	Isolation voltage (AC, 1 min., R.H. ≤ 60%) (Note)		BVS	2500	Vrms



Pin Configurations





- 4: Terminal 1
- 6: Terminal 2

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note) Device considered a two terminal device: Pins 1 and 3 shorted together and pins 4 and 6 shorted together.

Unit in mm

Recommended Operating Conditions

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V _{AC}	_	_	240	Vac
Forward current	١ _F	4.5	6	7.5	mA
Peak on-state current	I _{TP}	_	_	1	А
Operating temperature	T _{opr}	-10	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

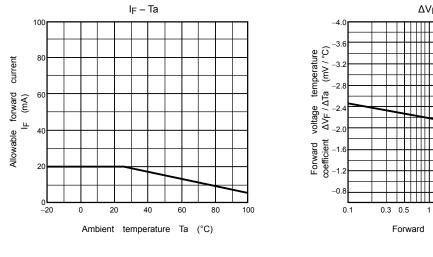
Individual Electrical Characteristics (Ta = 25°C)

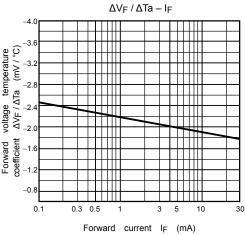
Characteristic		Symbol	Test Condition	Min.	Тур.	Max.	Unit
LED	Forward voltage	VF	I _F =10mA	1.2	1.4	1.7	V
	Reverse current	IR	V _R =3V	_	_	10	μA
	Capacitance	CT	V=0, f=1MHz	_	30	_	pF
Detector	Peak off-state current	IDRM	V _{DRM} =600V	_	10	1000	nA
	Peak on-state voltage	V _{TM}	I _{TM} =70mA	_	1.7	2.8	V
	Holding current	Iн	—	_	0.6	_	mA
	Critical rate of rise of off- state voltage	dv / dt	V _{in} =240Vrms, Ta=85°C	200	500	_	V / µs
	Critical rate of rise of commutating voltage	dv / dt(c)	V _{in} =60Vrms I _T =15mArms	_	0.2	_	V / µs

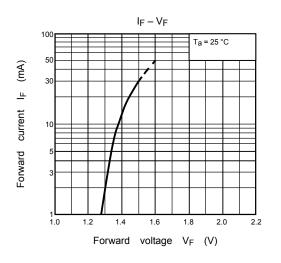
Coupled Electrical Characteristics (Ta = 25°C)

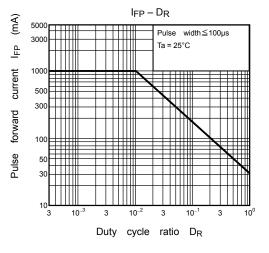
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Trigger LED current	IFT	V _T =6V	_	_	3	mA
Inhibit voltage	VIH	I _F =Rated I _{FT}	—	—	50	V
Leakage in inhibited state	IIН	I _F =Rated I _{FT} V _T = Rated V _{DRM}	—	200	600	μA
Capacitance (input to output)	Cs	V _S =0, f=1MHz	_	0.8	_	pF
Isolation resistance	R _S	V _S =500V, R.H. ≤ 60%	5×10 ¹⁰	10 ¹⁴	_	Ω
	BVS	AC, 1 minute	2500	_	_	Vrms
Isolation voltage		AC, 1 second, in oil	_	5000	_	VIIIS
		DC, 1 minute, in oil	_	5000	—	Vdc

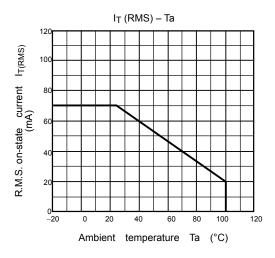
TOSHIBA







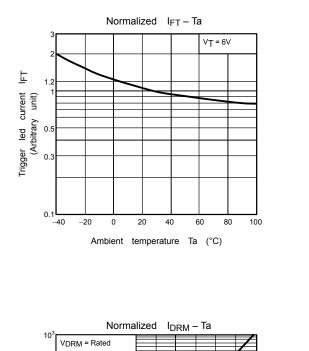


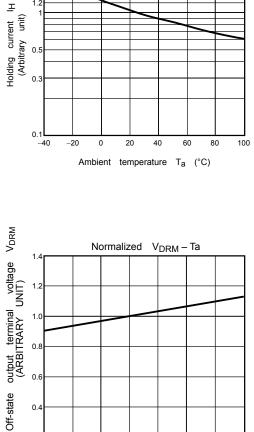


3

TOSHIBA

10

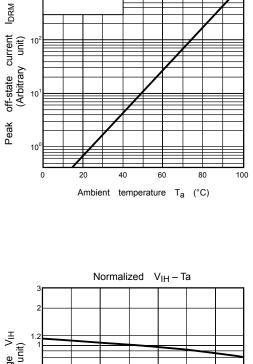


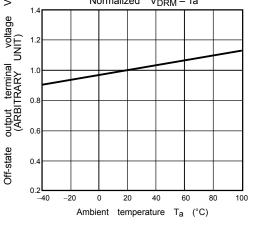


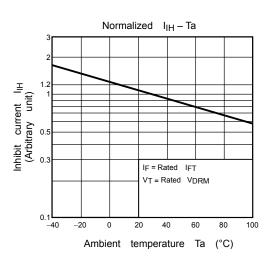
Normalized I_H - Ta

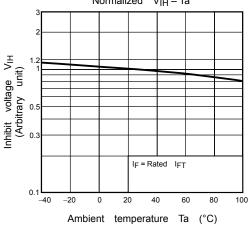
1.:

0.5









RESTRICTIONS ON PRODUCT USE

20070701-EN

- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
 In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in his document shall be made at the customer's own risk.
- The products described in this document shall not be used or embedded to any downstream products of which manufacture, use and/or sale are prohibited under any applicable laws and regulations.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patents or other rights of TOSHIBA or the third parties.
- GaAs(Gallium Arsenide) is used in this product. The dust or vapor is harmful to the human body. Do not break, cut, crush or dissolve chemically.
- Please contact your sales representative for product-by-product details in this document regarding RoHS compatibility. Please use these products in this document in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances. Toshiba assumes no liability for damage or losses occurring as a result of noncompliance with applicable laws and regulations.